

#### Features

- 1700-Volt Schottky Rectifier
- Zero Reverse Recovery Current
- Zero Forward Recovery Voltage
- High-Frequency Operation
- Temperature-Independent Switching Behavior
- Extremely Fast Switching
- Halogen-Free; RoHS Compliant

#### **Benefits**

- Replace Bipolar with Unipolar Rectifiers
- Essentially No Switching Losses
- Higher Efficiency
- Reduction of Heat Sink Requirements
- Parallel Devices Without Thermal Runaway



Part Number	Package	Marking	
HC3D10170A	TO220-2L	HC3D10170A	

# Maximum Ratings

Symbol	Parameter	Value	Unit	Test Conditions	Note
V <sub>RRM</sub>	Repetitive Peak Reverse Voltage	1700	v		
V <sub>RSM</sub>	Surge Peak Reverse Voltage	1700	v		
V <sub>DC</sub>	DC Blocking Voltage	1700	v		
I <sub>F</sub>	Continuous Forward Current	14.4	А	T <sub>c</sub> <135°C	
I <sub>frm</sub>	Repetitive Peak Forward Surge Current	45 26	А	$T_c=25$ °C, $t_p=10$ ms, Half Sine Wave, D=1 $T_c=110$ °C, $t_p=10$ ms, Half Sine Wave, D=1	
$\mathbf{I}_{FSM}$	Non-Repetitive Peak Forward Surge Current	55 41	А	$T_c=25$ °C, $t_p=10$ ms, Half Sine Wave, D=1 $T_c=110$ °C, $t_p=10$ ms, Half Sine Wave, D=1	
P <sub>tot</sub>	Power Dissipation	231 100	w	$T_c=25$ °C $T_c=110$ °C	
T <sub>c</sub>	Maximum Case Temperature	135	°C		
Т,	Operating Junction Range	-55 to +175	°C		
T <sub>stg</sub>	Storage Temperature Range	-55 to +135	°c		
	TO-247 Mounting Torque	1 8.8	Nm lbf-in	M3 Screw 6-32 Screw	



TO220-2L Package





### **Electrical Characteristics**

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
V <sub>F</sub>	Forward Voltage	1.7 3	2 3.5	V	$I_F = 10 \text{ A } T_J = 25^{\circ}\text{C}$ $I_F = 10 \text{ A } T_J = 175^{\circ}\text{C}$	
I <sub>R</sub>	Reverse Current	20 100	60 300	μA	V <sub>R</sub> = 1700 V T <sub>J</sub> =25°C V <sub>R</sub> = 1700 V T <sub>J</sub> =175°C	
Q <sub>c</sub>	Total Capacitive Charge	96		nC	$V_{R} = 1700 V, I_{F} = 10 A$ $di/dt = 200 A/\mu s$ $T_{J} = 25°C$	
с	Total Capacitance	827 78 41		pF	$V_{R} = 0 V, T_{J} = 25^{\circ}C, f = 1 MHz$ $V_{R} = 200 V, T_{J} = 25^{\circ}C, f = 1 MHz$ $V_{R} = 800 V, T_{J} = 25^{\circ}C, f = 1 MHz$	

Note:

**1.** This is a majority carrier diode, so there is no reverse recovery charge.

## **Thermal Characteristics**

Symbol	Parameter	Тур.	Unit
$R_{_{ ext{ heta}JC}}$	Thermal Resistance from Junction to Case	0.65	°C/W

# **Typical Performance**

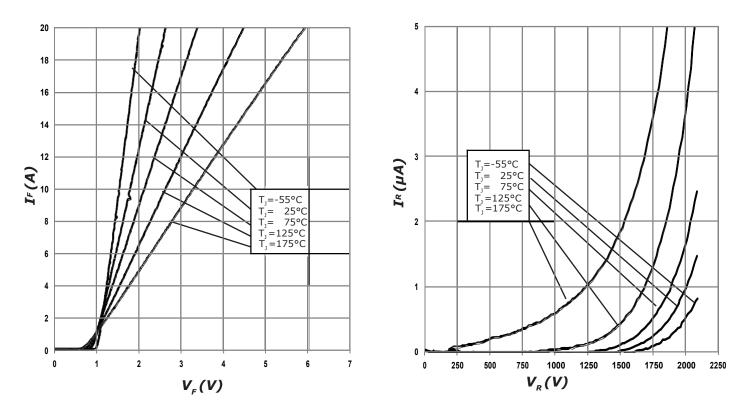
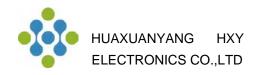


Figure 1. Forward Characteristics

Figure 2. Reverse Characteristics



### **Typical Performance**

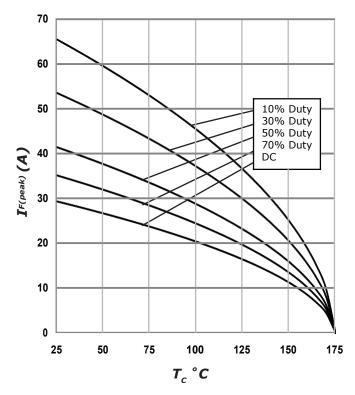


Figure 3. Current Derating

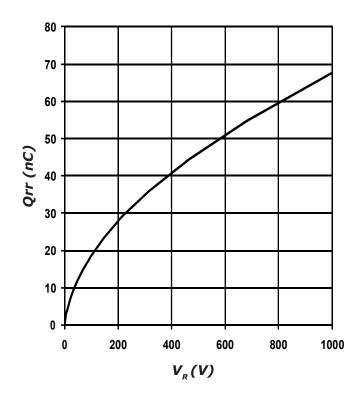
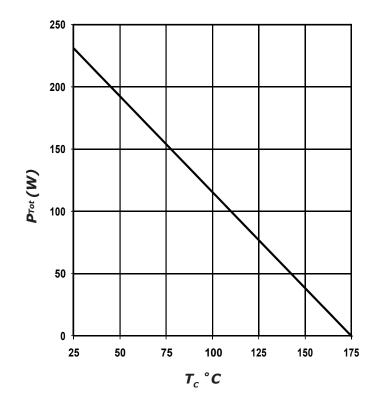
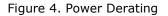
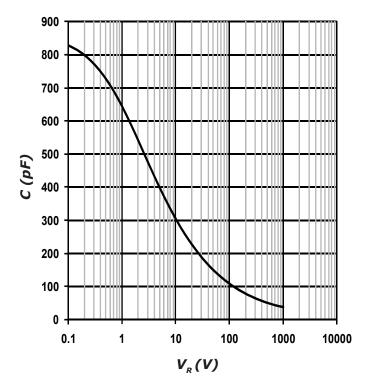
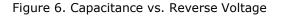


Figure 5. Recovery Charge vs. Reverse Voltage











#### **Typical Performance**

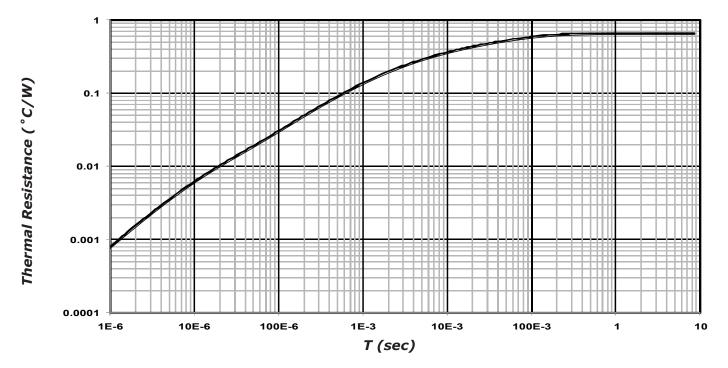
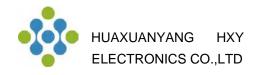


Figure 7. Transient Thermal Impedance

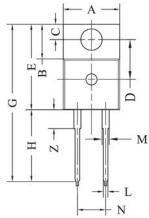


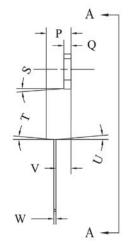
# **Package Dimensions**



PIN1 O

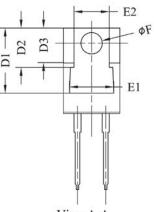
PIN 2 O





-Y-+

O CASE

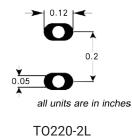


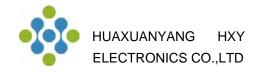
DOS	Inc	hes	Millimeters		
POS	Min	Max	Min	Max	
А	.381	.410	9.677	10.414	
В	.235	.255	5.969	6.477	
С	.100	.120	2.540	3.048	
D	.223	.337	5.664	8.560	
D1	.457	490	11.60-12.45 typ		
D2	.2773	303 typ	7.04-7	.70 typ	
D3	.2442	252 typ	6.22-6.4 typ		
E	.590	.615	14.986	15.621	
E1	.302	.326	7.68	8.28	
E2	.227	251	5.77	6.37	
F	.143	.153	3.632	3.886	
G	1.105	1.147	28.067	29.134	
Н	.500	.550	12.700	13.970	
L	.025	.036	.635	.914	
М	.045	.055	1.143	1.550	
Ν	.195	.205	4.953	5.207	
Р	.165	.185	4.191	4.699	
Q	.048	.054	1.219	1.372	
S	3°	6°	3°	6°	
Т	3°	6°	3°	6°	
U	3°	6°	3°	6°	
V	.094	.110	2.388	2.794	
W	.014	.025	.356	.635	
Х	3°	5.5°	3°	5.5°	
Y	.385	.410	9.779	10.414	
z	.130	.150	3.302	3.810	

View A-A

NOTE: 1. Dimension L, M, W apply for Solder Dip Finish

**Recommended Solder Pad Layout** 





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